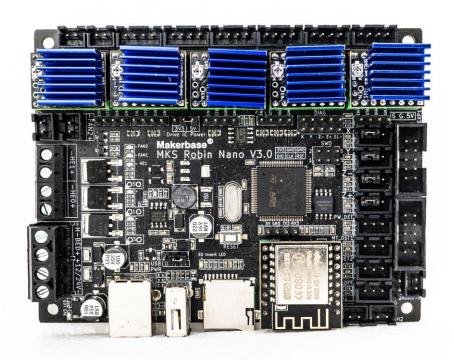
MKS Robin nano V3.0 使用 RRF 固件教程

1、 硬件



在 MKS Robin Nano V3 上插上 MKS Robin WIFI 模块即可,同时需要一个 FAT32 格式的 TF 卡。Robin Nano V3 刷了 RRF 之后,就不可以使用 TS35 显示屏来显示了,只能使用跟 Duet2Wifi 一样的串口屏,有 4.3/5.0/7.0 等几种规格。

2、 主板固件更新

主板 boot loader 和主板固件更新

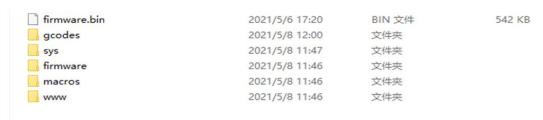
Robin Nano V3 原先的 BootLoader 不支持 RRF,所以需要先更新 bootloader,从 github(https://github.com/makerbase-mks/RepRapFirmware-for-MKS-Boards/tree/main/bootloader)下载以下文件复制到 TF 卡,然后上电,并等待更新完成。这个步骤是一次性的,更新后的 bootloader 同时支持 marlin 和 RRF 的更新了。

firmware.bin	2021/5/28 19:25	BIN 文件	520 KB
nano_v3_bootloader.bin	2021/5/10 12:10	BIN 文件	41 KB
Robin_nano_v3.bin	2021/5/10 10:41	BIN 文件	39 KB

更新主板 RRF 固件

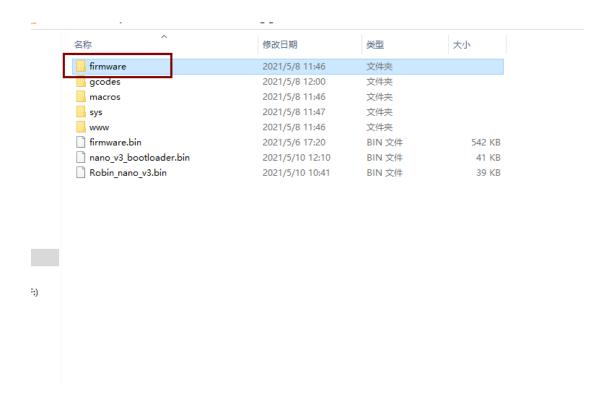
下 载

Github(https://github.com/makerbase-mks/RepRapFirmware-for-MKS-Boards/tree/main/release %20firmware/rrf v3.2)下的文件和文件夹,拷贝到 TF 卡上,插入主板并上电,等待主板上的 FAN1 的 led 灯亮起来,固件就更新完毕了。

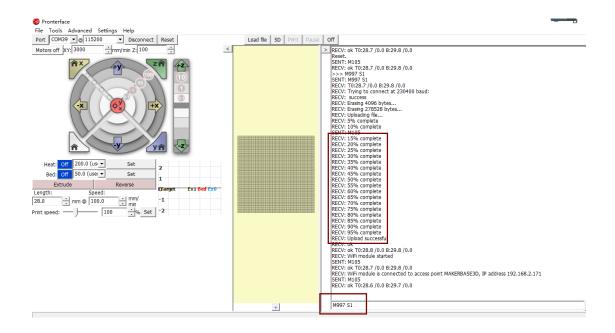


3. wifi 固件更新和 wifi 配置

确保 wifi 固件 DuetWiFiServer.bin 在 TF 卡的 firmware 文件夹下



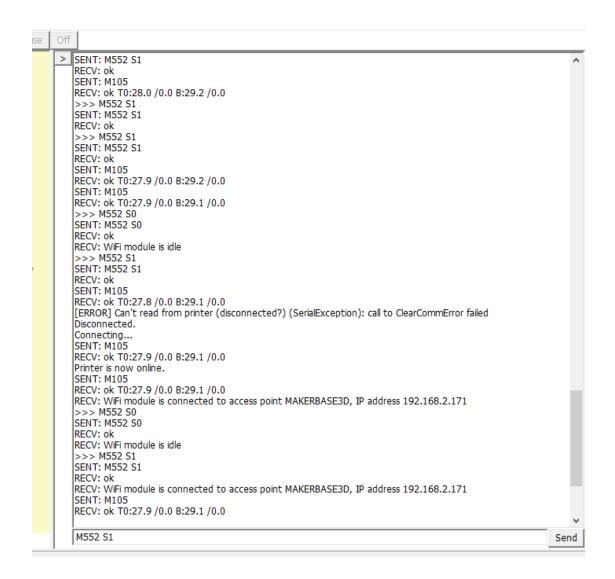
用上位机 Pronterface 或者其他电脑 Host 软件与主板连接,然后发送指令 M997 S1 进行 wifi 固件更新,固件更新过程 Pronterface 上会显示更新进度



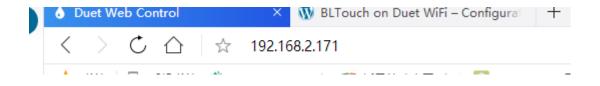
Wifi 名称和 wifi 密码设置,在上位机上发送指令 M587 S"wifi 名称" P"wifi 密码"

```
> RECV: 80% complete
   RECV: 85% complete
   RECV: 90% complete
   RECV: 95% complete
   RECV: Upload successful
   RECV: ok
   RECV: ok T0:28.8 /0.0 B:29.8 /0.0
   RECV: WiFi module started
   SENT: M105
   RECV: ok T0:28.7 /0.0 B:29.8 /0.0
   RECV: WiFi module is connected to access point MAKERBASE3D, IP address 192.168.2.171
   SENT: M105
   RECV: ok T0:28.6 /0.0 B:29.7 /0.0
   SENT: M105
   RECV: ok T0:28.5 /0.0 B:29.7 /0.0
   SENT: M105
   RECV: ok T0:28.4 /0.0 B:29.7 /0.0
   SENT: M105
   RECV: ok T0:28.5 /0.0 B:29.6 /0.0
   SENT: M105
   RECV: ok T0:28.4 /0.0 B:29.6 /0.0
   SENT: M105
   RECV: ok T0:28.3 /0.0 B:29.6 /0.0
   SENT: M105
   RECV: ok T0:28.3 /0.0 B:29.6 /0.0
   SENT: M105
   RECV: ok T0:28.3 /0.0 B:29.5 /0.0
   SENT: M105
   RECV: ok T0:28.3 /0.0 B:29.5 /0.0
   SENT: M105
   RECV: ok T0:28.2 /0.0 B:29.4 /0.0
   SENT: M105
   RECV: ok T0:28.2 /0.0 B:29.4 /0.0
   SENT: M105
   RECV: ok T0:28.2 /0.0 B:29.4 /0.0
   SENT: M105
   RECV: ok T0:28.0 /0.0 B:29.4 /0.0
   SENT: M105
   RECV: ok T0:28.0 /0.0 B:29.3 /0.0
   SENT: M105
   RECV: ok T0:27.9 /0.0 B:29.3 /0.0
   M587 S"makerbase" P"12345678"
                                                                                                        Send
```

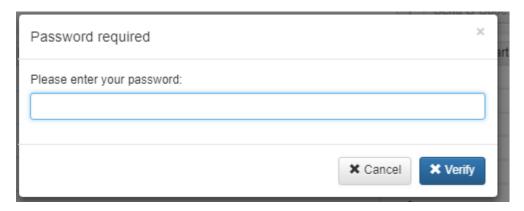
Wfi IP 查询,上位机发送指令 M552 S1



网页控制连接,在浏览器上输入 IP,点击进入



输入登录密码,该密码在配置文件中设置



```
; Configuration file for MKS SGen L v2.0 (firmware version 3)
; executed by the firmware on start-up
; generated by RepRapFirmware Configuration Tool v3.2.1-LPC on Wed Feb 03 2021
; General preferences
G90
                                                ; send absolute coordinates...
M83
                                                ; ...but relative extruder move
M550 P"My Printer"
                                                ; set printer name
M551 P"makerbase"
                                  ; Set password
M555 P2
                               ; Pl;like RepRapFirmare P2;like Marlin
M575 P1 B115200 S1
                               : Paneldue
; Network
M552 S1
                                                ; enable network
M586 PO S1
                                                ; enable HTTP
M586 P1 S0
                                                : disable FTP
M586 P2 S0
                                                ; disable Telnet
; Drives
M569 P0 S0
                                                ; physical drive 0 goes forward
M569 P1 S0
                                                ; physical drive 1 goes forward
M569 P2 S1
                                                ; physical drive 2 goes forward
M569 P3 S0
                                                · nhusical drive 3 does forward
```

3、机器参数配置文件修改

3.1 电机转动方向设置, S0 或 S1,转动方向不对后进行相反配置即可

(X 轴) physical drive 0 goes forwards using default driver timings M569 P1 S0 ; (X 轴) physical drive 1 goes forwards using default driver timings M569 P2 S1 ; (Z 轴) physical drive 2 goes forwards using default driver timings M569 P3 S0 ; (E0 轴) physical drive 2 goes forwards using default driver timings

3.2 脉冲设置

M92 X80.00 Y80.00 Z400.00 E420.00 ; set steps per mm

3.3 最大速度、加速度设置

M566 X900.00 Y900.00 Z60.00 E120.00 ; set maximum instantaneous speed changes

(mm/min)

M203 X6000.00 Y6000.00 Z180.00 E1200.00 ; set maximum speeds (mm/min) M201 X500.00 Y500.00 Z20.00 E250.00 ; set accelerations (mm/s^2)

3.4 打印平台范围设置

; Axis Limits

M208 X0 Y0 Z0 S1 ; set axis minima M208 X230 Y210 Z200 S0 ; set axis maxima

3.5 限位类型设置

; Endstops

M574 X1 S1 P"^xstop" ; configure active-high endstop for low

end on X via pin !^xstop

M574 Y1 S1 P"!^ystop" ; configure active-high endstop for low

end on Y via pin !^ystop

M574 Z1 S1 P"!^zstop" ; configure active-high endstop for low

end on Z via pin !^zstop

4、断料检测配置

在 enstops 配置中增加以下代码:

M591 D0 P1 C"e1stop" L7 R75:125 E22 S1 发,P2 高电平触发 ;configure runout_sensor P1 低电平触

5、使能 PanelDue 屏幕

在配文件中增加指令:

M575 P1 B115200 S2

; enable support for PanelDue

```
D:\RRF\R
; Heaters
M308 S0 P"bedtemp" Y"thermistor" T100000 B4138 ; configure sensor 0 as the
M950 H0 C"bed" T0
                                               ; create bed heater output
M307 H0 B0 S1.00
                                               ; disable bang-bang mode fo
M140 H0
                                               ; map heated bed to heater
M143 H0 S120
                                               ; set temperature limit for
M143 H0 S120
                                               ; set temperature limit for
M308 S1 P"e0temp" Y"thermistor" T100000 B4138 ; configure sensor 1 as the
                                               ; create nozzle heater outp
M950 H1 C"e0heat" T1
M307 H1 B0 S1.00
                                               ; disable bang-bang mode fo
M143 H1 S280
                                               ; set temperature limit for
; Fans
M950 F0 C"fan0" Q500
                                               ; create fan 0 on pin fan0
M106 P0 S0 H-1
                                               ; set fan 0 value. Thermost
; Tools
M563 P0 D0 H1 F0
                                               ; define tool 0
G10 P0 X0 Y0 Z0
                                               ; set tool 0 axis offsets
G10 P0 R0 S0
                                               ; set initial tool 0 active
; Custom settings are not defined
; Miscellaneous
M575 P1 B115200 S2
                                             ; enable support for PanelDue
                                                ; load saved parameters fro
                                            ; select first tool
; Automatic power saving
M911 S21 R22 P"M913 X0 Y0 G91 M83 G1 Z3 E-5 F1000" ; Set voltage threshold
```

6、3Dtouch 配置

```
6.1 在配置文件中增加以下指令;
```

;Z-Probe

M950 S0 C"servo0" ; Setup servo 0 as servo

M558 P9 C"^zstopmax" H5 F120 T6000 ; set Z probe type to bltouch and the dive

height + speeds

G31 P500 X26 Y0 Z2.1 ; set X offse\Y offset1\Trigger Z height

M557 X30:150 Y10:150 S20 ; define mesh grid M375 ; Load height map

```
M201 X500.00 Y500.00 Z100.00 E500.00 ; set accelerations (mm/s^
M906 X800 Y800 Z800 E800 I30
                                           ; set motor currents (mA) a
M84 S30
                                          ; Set idle timeout
; Axis Limits
M208 X0 Y0 Z0 S1
                                           ; set axis minima
M208 X180 Y180 Z200 S0
                                           ; set axis maxima
; Endstops
M574 X1 S1 P"!^xstop"
                                            ; configure active-high er
M574 Y1 S1 P"!^ystop"
                                          ; configure active-high end
M574 Z1 S1 P"!^zstop"
                                          ; configure active-high end
M591 D0 P1 C"e1stop" L7 R75:125 E22 S1
                                           : configure runout sensor
; Z-Probe
M950 S0 C"servo0"
                                           ; Setup servo 0 as servo
M558 P9 C"^zstopmax" H5 F120 T6000
                                           ; set Z probe type to bltou
                                           ; set X offse\Y offset1\Tri
G31 P500 X26 Y0 Z2.1
M557 X30:150 Y10:150 S20
                                           ; define mesh grid
м375
                                           ; Load height map
; Heaters
M308 S0 P"bedtemp" Y"thermistor" T100000 B4138 ; configure sensor 0 as the
M950 H0 C"bed" T0
                                           ; create bed heater output
M307 H0 B0 S1.00
                                           ; disable bang-bang mode fo
M140 H0
                                           ; map heated bed to heater
M143 H0 S120
                                           ; set temperature limit for
M143 H0 S120
                                           ; set temperature limit for
M308 S1 P"e0temp" Y"thermistor" T100000 B4138 ; configure sensor 1 as the
M950 H1 C"e0heat" T1
                                          ; create nozzle heater outr
M307 H1 B0 S1.00
                                           ; disable bang-bang mode fo
```

- 6.2 在 sys 文件夹中增加 deployprobe.g 文件, 文件里面的指令为: M280 P0 S10
- 6.3 在 sys 文件夹中增加 retractprobe.g 文件, 文件里面的指令为: M280 P0 S90
- 6.4 在 sys 文件夹中增加 heightmap.csv 文件,该文件用于保存测量的高度数据
- 6.5 在 sys 文件夹中增加 bed.g 文件,文件里面的指令为

M561

G29

6.6 在 macros 文件夹中增加控键 AUTO_BED_LEVELING,该控键用于在屏上进行操作自动调平,里面的指令为

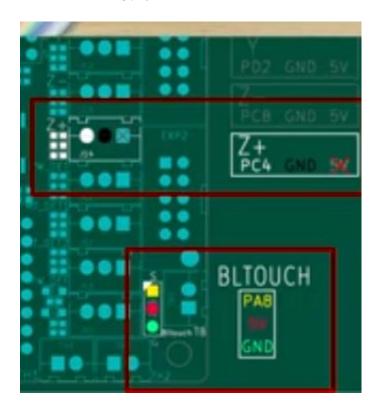
M280 P0 S160

G28

G32

6.7 在 macros 文件夹中增加控键 Alarm Release,里面的指令为 M280 P0 S160,该 控键用于解除 3Dtouch 报警

6.8, 3Dtouch 接线



6.9 Zoffset 调整,详情参考以下链接中的教程

 $\frac{https://betrue3d.\,dk/b1touch-on-duet-wifi-configuratio-and-usage/\#macrogroup}{ogroup}$